

KA3012D

4-Channel Motor Driver

Features

- BTL (H-Bridge type linear) 4channel motor driver
- Wide dynamic range:
 - $SV_{CC}=12V, PV_{CC1}=5V, R_L=8\Omega \rightarrow V_{OM}=4.2V$
 - $SV_{CC}=12V, PV_{CC2}=12V, R_L=24\Omega \rightarrow V_{OM}=10.4V$
- Built in level-shift circuit
- Built in OP-amp for digital input
- Built in thermal shutdown (TSD) circuit
- Three independent sources
- Low crossover distortion
- Built-in reverse rotation prevented
- Built-in short breaker

Description

The KA3012D is a monolithic IC, and suitable for 4-CH motor driver which drives sled motor, loading motor, focus & tracking actuator of CD-media system and built in OP-amp which can receive digital signal from servo of CD-media system.



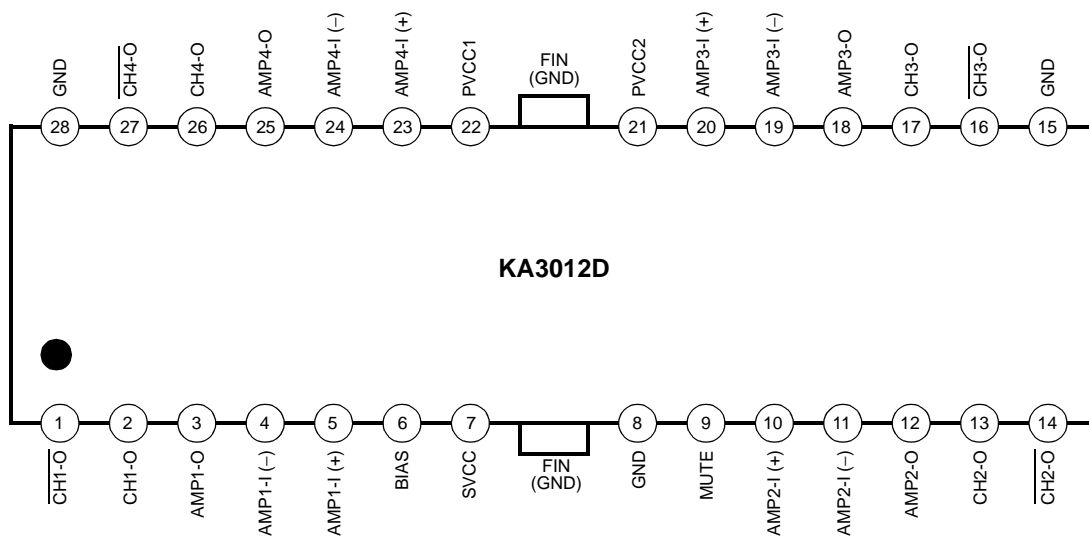
Typical Applications

- Compact disk ROM (CD-ROM)
- Compact disk RW (CD-RW)
- Digital video disk ROM (DVD-ROM)
- Digital video disk RAM (DVD-RAM)
- Digital video disk player (DVDP)
- Other compact disk media

Ordering Information

Device	Package	Operating Temp.
KA3012D-02	28-SSOPH-375	-35 °C ~ 85 °C
KA3012D-02TF	28-SSOPH-375	-35 °C ~ 85 °C

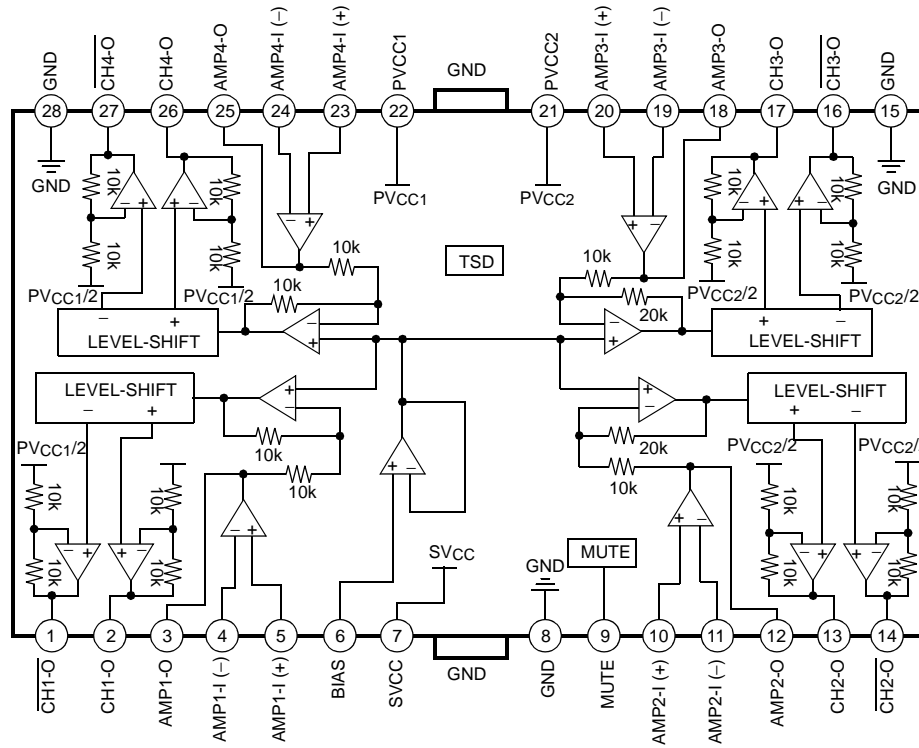
Pin Assignments



Pin Definitions

Pin Number	Pin Name	I/O	Pin Function Description
1	CH1-O	O	Drive CH 1 output (-)
2	CH1-O	O	Drive CH 1 output (+)
3	AMP1-O	O	Op-amp CH 1 output
4	AMP1-I(-)	I	Op-amp CH 1 input (-)
5	AMP1-I(+)	I	OP-amp CH 1 input (+)
6	BIAS	I	Bias input
7	SVCC	-	Supply voltage (Signal)
8	GND	-	Ground
9	MUTE	I	Mute
10	AMP2-I(+)	I	OP-amp CH 2 input (+)
11	AMP2-I(-)	I	Op-amp CH 2 input (-)
12	AMP2-O	O	Op-amp CH 2 output
13	AMP2-O	O	OP-amp CH 2 output (+)
14	CH2-O	O	Op-amp CH 2 output (Op-amp CH 2 output)
15	GND	-	Ground
16	CH3-O	O	Drive CH 3 output (-)
17	CH3-O	O	Drive CH 3 output (+)
18	AMP3-O	O	OP-amp CH 3 output
19	AMP3-I(-)	I	Drive CH 3 input (-)
20	AMP3-I(+)	I	Drive CH 3 input (+)
21	PVCC2	-	Supply voltage (CH 2 & CH 3)
22	PVCC1	-	Supply voltage (CH1 & CH 4)
23	AMP4-I(+)	I	OP-amp CH 4 input (+)
24	AMP4-I(-)	I	Op-amp CH 4 input (-)
25	AMP4-O	O	Op-amp CH 4 output
26	CH4-O	O	Drive CH 4 output (+)
27	CH4-O	O	Drive CH 4 output (-)
28	GND	-	Ground

Internal Block Diagram



NOTE:

The drive channel outputs are determined pre OP-amp output.

Equivalent Circuits

Op-amp input	Op-amp output
<p>AMP-I (+) 5, 10, 20, 23 Pin</p> <p>AMP-I (-) 4, 11, 19, 24 Pin</p>	<p>80Ω</p> <p>AMP-O 3, 12, 17, 25 Pin</p> <p>80Ω</p>
Drive output	Bias
<p>10kΩ</p> <p>CH-O (2, 13, 17, 26 Pin)</p> <p>CH-O (1, 14, 16, 27 Pin)</p> <p>1kΩ</p>	<p>Bias (6 Pin)</p> <p>200Ω</p>
Mute	
<p>Mute (9 Pin)</p> <p>50k</p> <p>50k</p>	

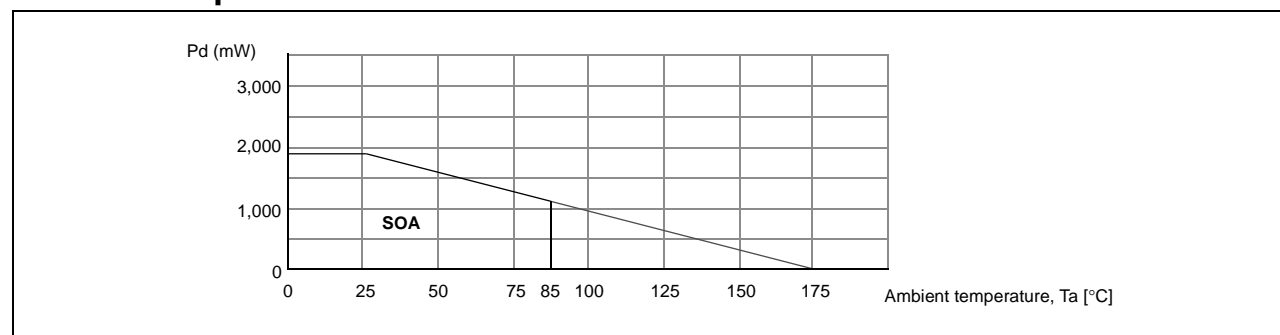
Absolute Maximum Rating (Ta = 25°C)

Parameter	Symbol	Value	Unit
Supply voltage	V _{CC}	15	V
Power dissipation	P _D	1.7 ^{note}	W
Operating temperature range	T _{OPR}	-35 ~ +85	°C
Storage temperature range	T _{STG}	-55 ~ +150	°C

NOTE:

1. When mounted on 50mm × 50mm × 1mm PCB (Phenolic resin material).
2. Power dissipation reduces 13.6mW / °C for using above Ta=25°C.
3. Do not exceed P_D and SOA (Safe operating area).

Power Dissipation Curve



Recommended Operating Condition (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	SV _{CC} , V _{CC1} , V _{CC2}	4.5	-	13.2	V

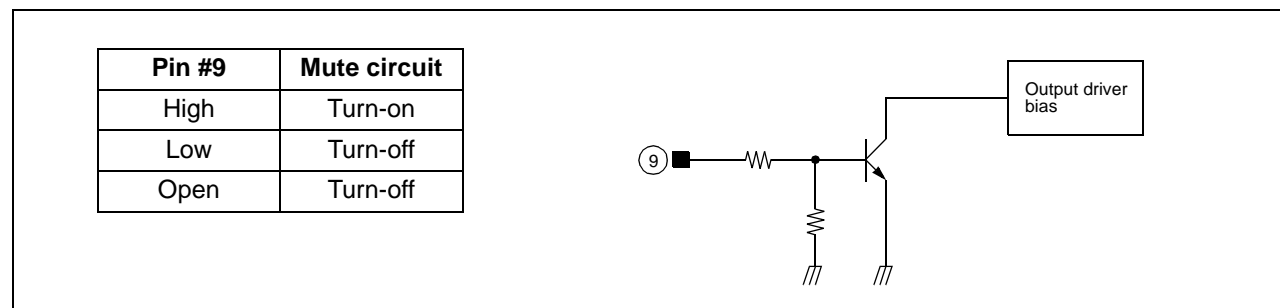
Electrical Characteristics

($T_a=25^\circ\text{C}$, $V_{CC1}=V_{CC2}=5\text{V}$, $R_L=8\Omega$)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
DRIVE CIRCUIT						
Quiescent current 1	I_{CC1}	No load, Mute off	-	15	20	mA
Quiescent current 2	I_{CC2}	No load, Mute on	-	-	500	μA
Output offset voltage 1	V_{OO1}	CH 1, CH 4	-70	0	70	mV
Output offset voltage 2	V_{OO2}	CH 2, CH 3	-90	-	90	mV
Max.output amplitude 1	V_{OM1}	CH 1, CH 4	3	4.2	-	V
Max.output amplitude 2	V_{OM2}	CH 2, CH 3 ($R_L=24\Omega$)	8	10.4	-	V
Voltage gain 1	G_{VC1}	$V_{IN}=0.1V_{RMS}$, 1kHz, sinewave. Input OP-amp → Buffer CH 1, CH 4	10	12.0	14	dB
Voltage gain 2	G_{VC2}	$V_{IN}=0.1V_{RMS}$, 1kHz, sinewave. Input OP-amp → Buffer CH 2, CH 3	16	18	20	dB
Mute on voltage	V_{Mon}	-	2.0	-	-	V
Mute off voltage	V_{Moff}	-	-	-	0.5	V
INPUT OP-AMP CIRCUIT						
Input offset voltage	V_{OFOP}	-	-10	0	10	mV
Input bias current	I_{BOP}	-	-	-	300	nA
High level output voltage	V_{OHOP}	-	10	10.9	-	V
Low level output voltage	V_{OLOP}	-	-	1.1	1.8	V
Output driving current sink	I_{SINK}	Input op-amp output → V_{CC} & $1.2k\Omega$	1	-	-	mA
Output driving current source	I_{SOURCE}	Input op-amp output → GND & $1.2k\Omega$	1	-	-	mA
Slew rate	SR	100kHz square-wave 2Vp-p output	-	1	-	$\text{V} / \mu\text{s}$

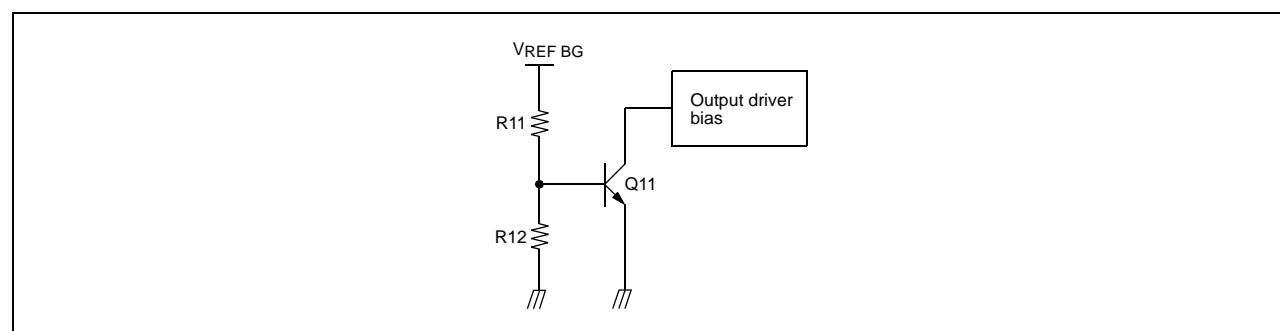
Application Information

1. MUTE



- When the voltage level of the mute pin is above 2V, the mute circuit is activated so that the output circuit will be muted.
- When the mute pin #9 is open or the voltage of the mute pin #9 is below 0.5V, the mute circuit is deactivated and the output circuit operates normally.
- When the mute circuit is activated, the voltage level of output pins becomes $1/2V_{CC}$ (approximately).

2. TSD (THERMAL SHUTDOWN)

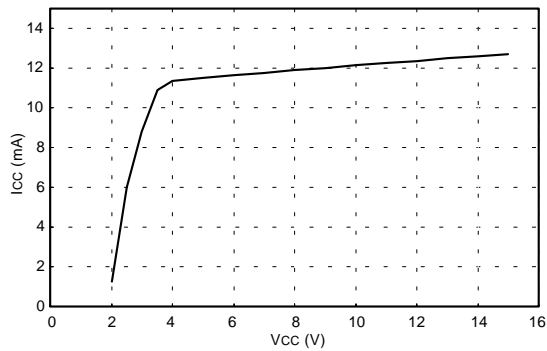


- If the chip temperature rises above 175°C, then the TSD (Thermal shutdown) circuit is activated and the output circuit is muted.
- The $V_{REF\ BG}$ is the output voltage of the band-gap-referenced bias in circuit and acts as the input voltage of the TSD circuit.
- The base-emitter voltage of the TR, Q11 is designed to turn-on at 460mA.

$$V_{BE} = V_{REF\ BG} \times R12 / (R11 + R12) = 460mV$$
- When the chip temperature rises up to 175°C, the turn-on voltage of the Q11 drops down to 460mV. (Hysteresis: 25°C) and Q11 turns on so the output circuit is muted.

Typical Performance Characteristics

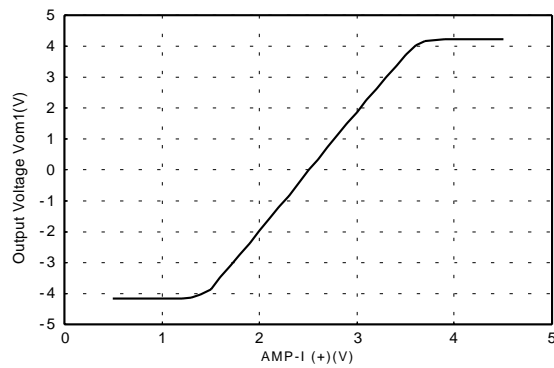
VCC vs ICC (No load)



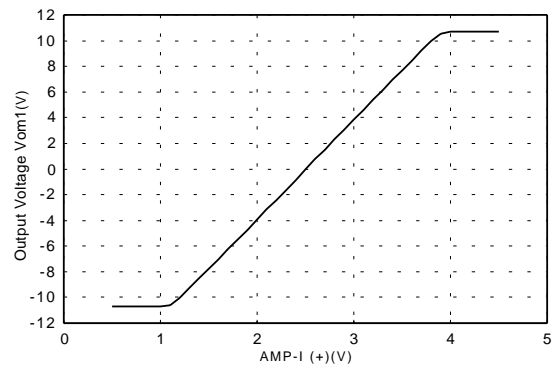
AMP-I (+) vs OUTPUT VOLTAGE

Figures can be obtained by changing of AMP-I (+) from 0V to 5V, shows the voltage difference between CH-O and CH-O. (AMP-I (+) and AMP-O are shorted.)

1. CH 1 and CH 4 (12dB)

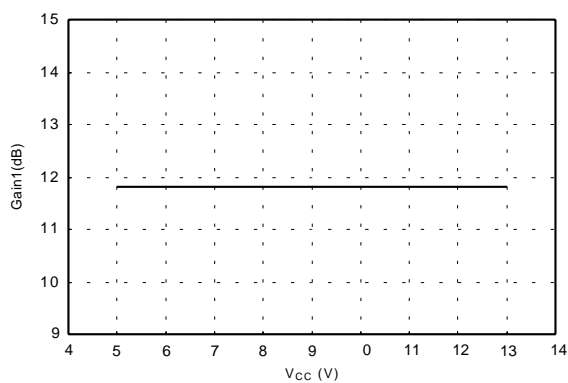


2. CH 2 and CH 3 (18dB)

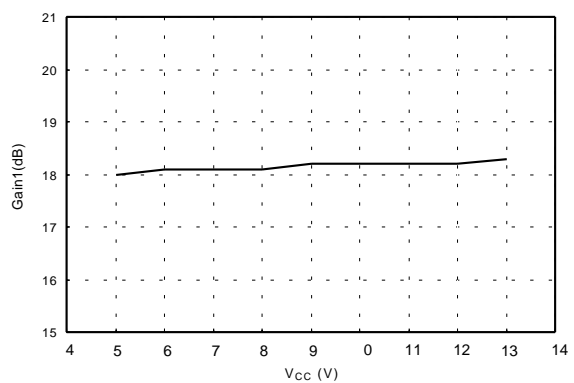


VCC vs Gain

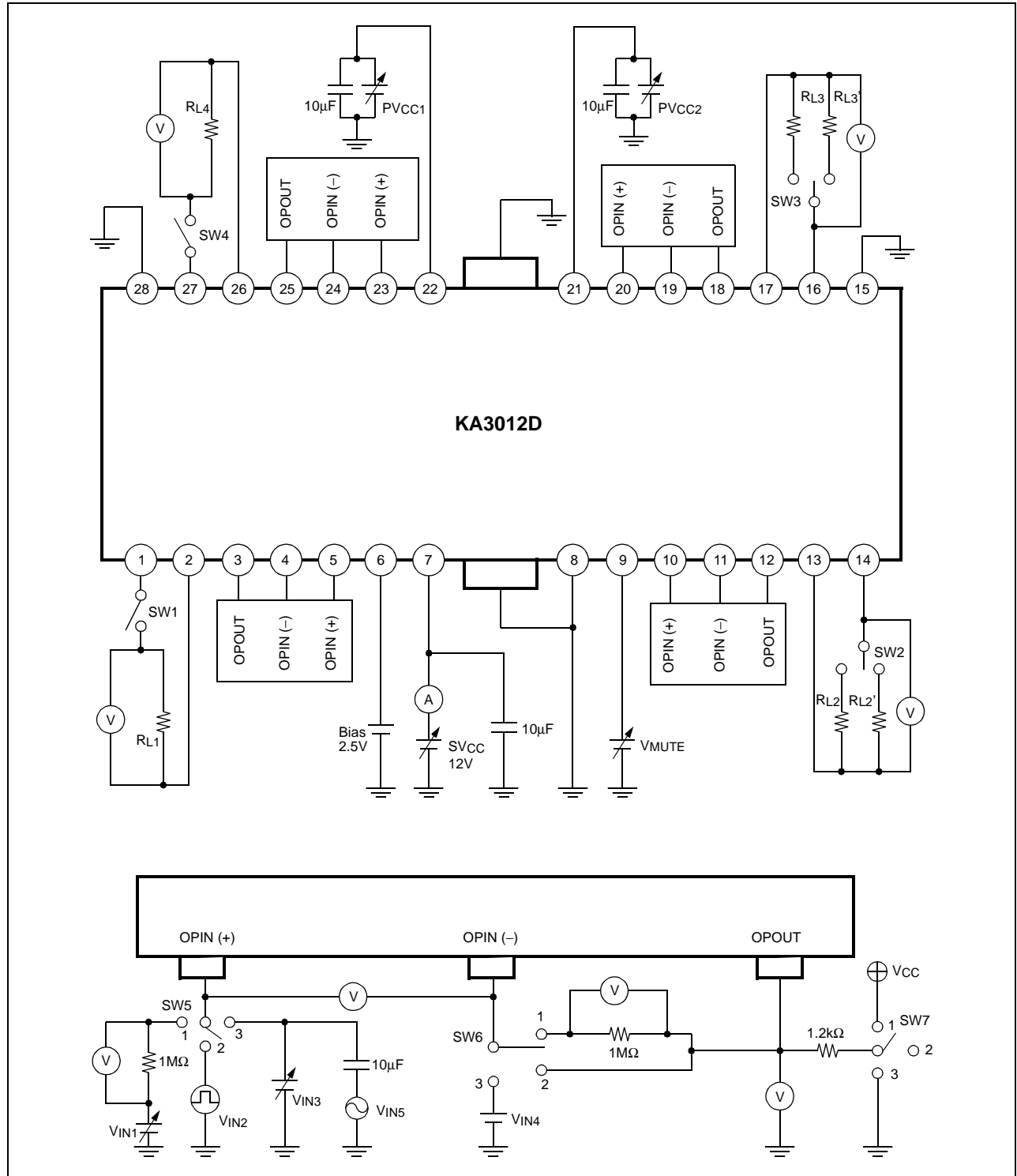
1. CH 1 and CH 4 (12dB)



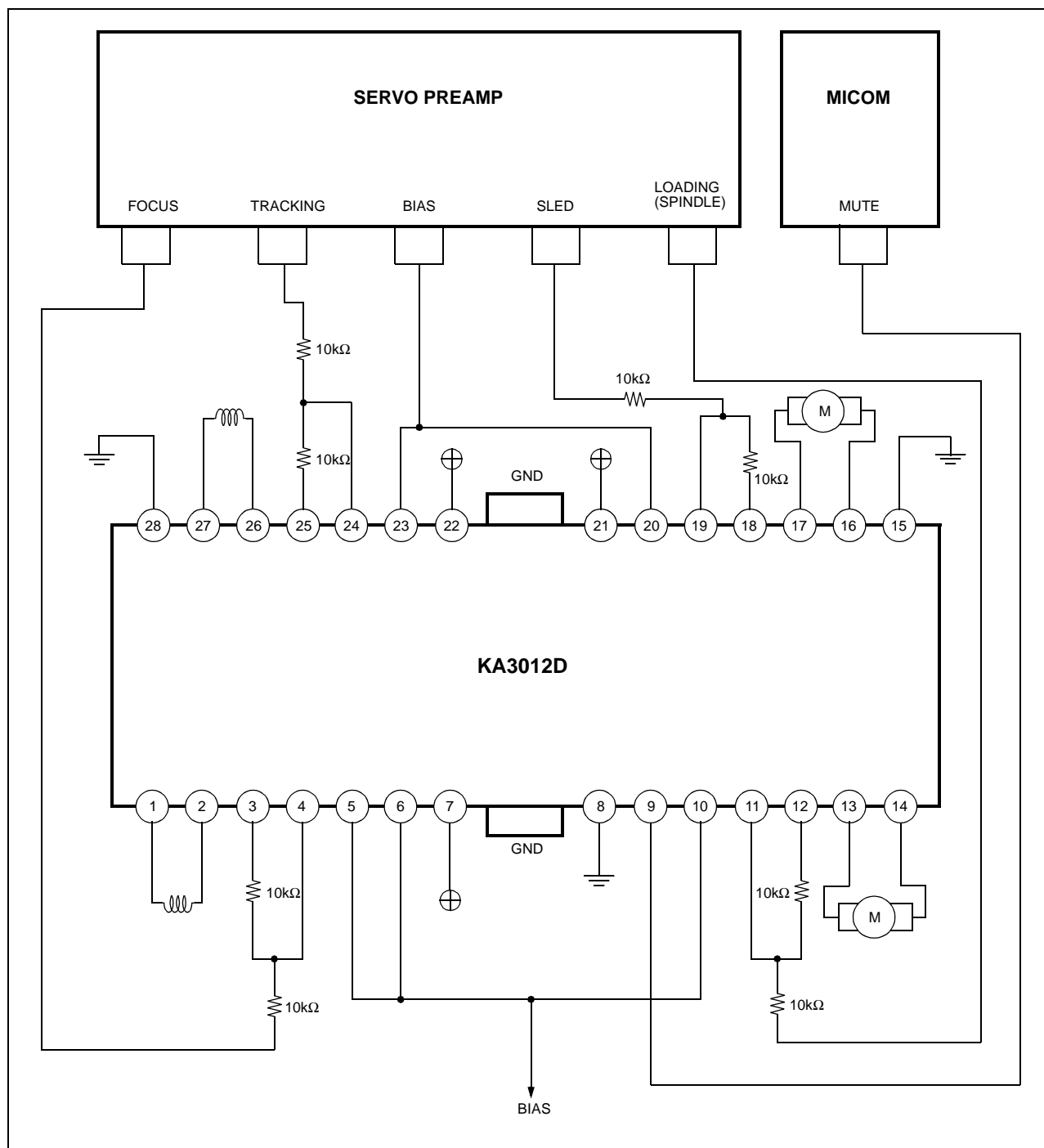
2. CH 2 and CH 3 (18dB)



Test Circuits



Typical Application Circuits



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